

05/28/99

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May 28, 1999

BOX PATENT APPLICATION

Assistant Commissioner for Patents

Washington, D.C. 20231

Re: **New U.S. Patent Application of**
Inventors: Lee C. HAROLD, Qing ZHU and Herbert LIEBL
Title: "System And Method For Network User Interface OLAP Report
Formatting"

Dear Sir:

Attached is a new application for filing in the United States Patent and Trademark Office, including thirty-seven (37) pages of specification, four (4) pages of claims, an Abstract, seven (7) pages of drawings (Figures 1-7) and an unexecuted Joint Declaration for Patent Application.

The filing fee is calculated as follows:

Basic Filing Fee:	\$760.00
Total Claims: 23	54.00
Independent Claims: 3	<u>0.00</u>
Total Filing Fee:	\$814.00

This application is being filed without a filing fee and without an executed Declaration under 37 C.F.R. § 1.53(d). Accordingly, applicants are believed to be entitled to a filing date based upon the U.S. Patent and Trademark Office's receipt of the attached specification and drawings. Therefore, it is respectfully requested that a filing date of May 28, 1999 be granted to this application. The filing fee and executed Declaration will be timely filed.

The undersigned's Deposit Account No. is 50-0206. A duplicate of this sheet is attached.

HUNTON & WILLIAMS

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May 28, 1999

Page 2

Please direct all communication concerning this application to:

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Respectfully submitted,

By: Brian M. Buroker
Brian M. Buroker
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BMB/smm

Enclosures